

این دیتاشیت توسط توکل الکترونیک تهیه و ارائه شده است.
جهت مشاهده قیمت، موجودی و ثبت سفارش این قطعه به وبسایت توکل الکترونیک مراجعه فرمایید.


مشاهده قیمت و خرید

برای خرید و مشاهده سایر محصولات کلیک کنید



IRFS630/631

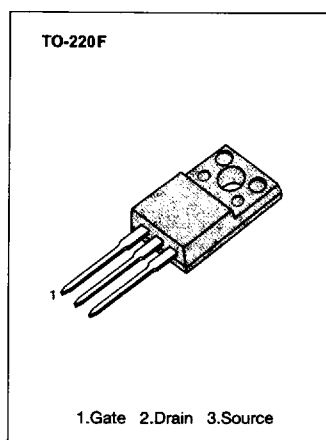
N-CHANNEL POWER MOSFETS

FEATURES

- Lower $R_{DS(on)}$
- Improved inductive ruggedness
- Fast switching times
- Rugged polysilicon gate cell structure
- Lower input capacitance
- Extended safe operating area
- Improved high temperature reliability

PRODUCT SUMMARY

Part Number	V _{DS}	R _{DS(on)}	I _D
IRFS630	200V	0.4 Ω	5.9A
IRFS631	150V	0.4 Ω	5.9A



ABSOLUTE MAXIMUM RATINGS

Characteristic	Symbol	IRFS630	IRFS631	Unit
Drain-Source Voltage (1)	V _{DSS}	200	150	V _{dc}
Drain-Gate Voltage ($R_{GS}=1.0M\Omega$) (1)	V _{BGR}	200	150	V _{dc}
Gate-Source Voltage	V _{GS}	± 20		V _{dc}
Continuous Drain Current $T_C=25^\circ C$	I _D	5.9		A _{dc}
Continuous Drain Current $T_C=100^\circ C$	I _D	4.1		A _{dc}
Drain Current - Pulsed (3)	I _{DM}	36		A _{dc}
Gate Current - Pulsed	I _{GM}	± 1.5		A _{dc}
Single Pulsed Avalanche Energy (4)	E _{AS}	78		mJ
Avalanche Current	I _{AS}	5.9		A
Total Power Dissipation at $T_C=25^\circ C$	P _D	35		Watts
Derate above $25^\circ C$		0.28		W/ $^\circ C$
Operating and Storage Junction Temperature Range	T _J , T _{STG}	-55 to +150		$^\circ C$
Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5 seconds	T _L	300		$^\circ C$

 Notes : (1) $T_J=25^\circ C$ to $150^\circ C$

 (2) Pulse test : Pulse width $\leq 300\mu s$, Duty Cycle $\leq 2\%$

(3) Repetitive rating : Pulse width limited by max. junction temperature

 (4) $L=4mH$, $V_{GS}=50V$, $R_G=25\Omega$, Starting $T_J=25^\circ C$

ELECTRICAL CHARACTERISTICS ($T_c=25^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Min	Typ	Max	Units	Test Conditions
BV _{DSS}	Drain-Source Breakdown Voltage					
	IRFS630	200	-	-	V	V _{GS} =0V, I _D =250 μ A
	IRFS631	150	-	-	V	
V _{GS(th)}	Gate Threshold Voltage	2.0	-	4.0	V	V _{DS} =V _{GS} , I _D =250 μ A
I _{GSS}	Gate-Source Leakage Forward	-	-	100	nA	V _{GS} =20V
I _{GSS}	Gate-Source Leakage Reverse	-	-	-100	nA	V _{GS} =-20V
I _{DSS}	Zero Gate Voltage Drain Current	-	-	250	μ A	V _{DS} =Max. Rating, V _{GS} =0V
		-	-	1000	μ A	V _{DS} =0.8 Max. Rating, V _{GS} =0V, T _c =125 $^\circ\text{C}$
R _{DS(on)}	Static Drain-Source On Resistance(2)	-	-	0.4	Ω	V _{GS} =10V, I _D =4.5A
g _{fs}	Forward Transconductance (2)	3	4.6	-	mS	V _{DS} $\geq$ 50V, I _D =4.5A
C _{iss}	Input Capacitance	-	750	-	pF	V _{GS} =0V, V _{DS} =25V, f=1.0MHz
C _{oss}	Output Capacitance	-	120	-	pF	
C _{rss}	Reverse Transfer Capacitance	-	45	-	pF	
t _{d(on)}	Turn-On Delay Time	-	-	30	ns	V _{DD} =0.5 BV _{DSS} , I _D =9.0A, Z _o =18 Ω (MOSFET switching times are essentially independent of operating temperature)
t _r	Rise Time	-	-	50	ns	
t _{d(off)}	Turn-Off Delay Time	-	-	50	ns	
t _f	Fall Time	-	-	40	ns	
Q _g	Total Gate Charge (Gate-Source Plus Gate-Drain)	-	-	34	nC	V _{GS} =10V, I _D =9.0A, V _{DS} =0.8 Max. Rating (Gate charge is essentially independent of operating temperature)
Q _{gs}	Gate-Source Charge	-	6.1	-	nC	
Q _{gd}	Gate-Drain ("Miller") Charge	-	12.7	-	nC	

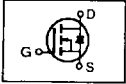
THERMAL RESISTANCE

Symbol	Characteristics		All	Units	Remark
R _{thJC}	Junction-to-Case	MAX	3.57	K/W	
R _{thCS}	Case-to-Sink	TYP	0.5	K/W	Mounting surface flat, smooth and greased
R _{thJA}	Junction-to-Ambient	MAX	62.5	K/W	Free Air Operation

Notes : (1) T_J=25 $^\circ\text{C}$ to 150 $^\circ\text{C}$ (2) Pulse test : Pulse width $\leq$ 300 μ s, Duty Cycle $\leq$ 2%

(3) Repetitive rating : Pulse width limited by max. junction temperature

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic	Min	Typ	Max	Units	Test Conditions
I_S	Continuous Source Current (Body Diode)	-	-	9.0	A	Modified MOSFET symbol showing the integral reverse P-N junction rectifier 
I_{SM}	Pulse Source Current (Body Diode) (3)	-	-	36	A	
V_{SD}	Diode Forward Voltage (2)	-	-	3.0	V	$T_J=25^\circ\text{C}$, $I_S=9.0\text{A}$, $V_{GS}=0\text{V}$
t_{rr}	Reverse Recovery Time	-	450	-	ns	$T_J=25^\circ\text{C}$, $I_F=9.0\text{A}$, $dI_F/dt=100\text{A}/\mu\text{S}$

Notes : (1) $T_J=25^\circ\text{C}$ to 150°C (2) Pulse test : Pulse width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$

(3) Repetitive rating : Pulse width limited by max. junction temperature

